

ORIGINAL RESEARCH ARTICLE

Enhancing interlaminar adhesion in multi-material 3D printing: A study of conductive PLA and TPU interfaces via fused filament fabrication

Supplementary File

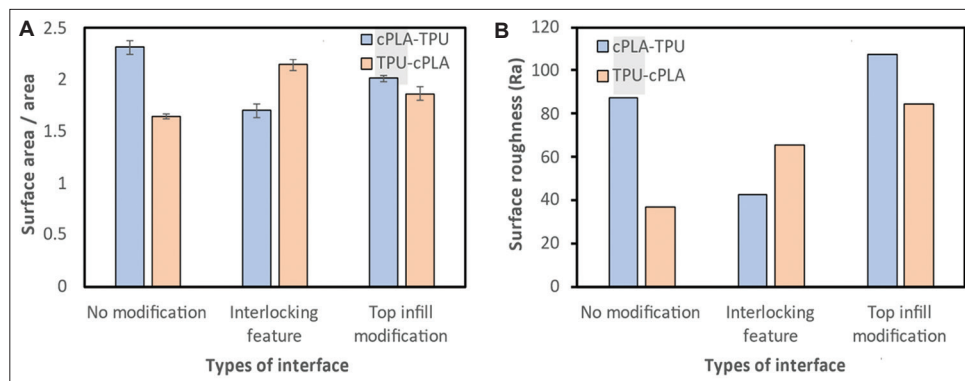


Figure S1. Graphs showing the (A) surface area/area ratio and (B) surface roughness (R_a) for the last printed interfaces.